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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/895,319	07/02/2001	Toshiaki Shinohara	210314US2	6650	
	02/24/2003		EXAMINER		
OBLON, SPIVAK, MCCLELLAND, MAIER & NEUSTADT, P.C. 1940 DUKE STREET			NGUYEN, DILINH P		
ALEXANDRIA, VA 22314			ART UNIT	PAPER NUMBER	
			2814		

DATE MAILED: 02/24/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s) SHINOHARA, TOSHIAKI		
9/895, 319			
xaminer	Art Unit		
iLinh Nguyen	2814		

		DiLinh Nguyen	2814					
	The MAILING DATE of this communication appe	ars on the cover sheet with the	orrospondonos add					
ı	The MAILING DATE of this communication appears on the cover sheet with the correspondence address THE REPLY FILED 19 January 2005 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE.							
	1. \(  The reply was filed after a final rejection, but prior to filing a Notice of Appeal. To avoid abandonment of this application,							
	Request for Continued Examination (RCE) in compliance with 37 CFR 1.31; or (3) a time periods:							
l	a) The period for reply expires 3 months from the mailing date of	the final rejection.						
	b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In nevent, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection. Examine Mote if Box is checked exhaust the best of the statutory of the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection.							
l	Examiner Note: If box 1 is checked, check either box (a) or (b). ONLY CHECK BOX (b) WHEN THE FIRST REPLY WAS FILED WITHIN T MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).							
	Extensions of time may be obtained under 37 CFR 1.136(a). The date on been filed is the date for purposes of determining the period of extension at CFR 1.17(a) is calculated from: (1) the expiration date of the shortened statebowe, if checked. Any reply received by the Office later than three months earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL	id the corresponding amount of the fee.	The appropriate extension	n fee under 37				
	2. The reply was filed after the date of filing a Notice of Appe	al but prior to the data of files						
	Appeal (37 CFR 41.37(a)), or any extension thereof (37 CA) Appeal has been filed, any reply must be filed within the ti AMENDMENTS	.37 must be filed within two month FR 41.37(e)), to avoid dismissal of me period set forth in 37 CFR 41.3	ns of the date of filing f the appeal. Since a 37(a).	the Notice of Notice of				
	3. The proposed amendment(s) filed after a final rejection, b	out prior to the date of filing a brief,	will not be entered b	ecause				
	(b) They raise new issues that would require further con	sideration and/or search (see NOT	E below);					
	<ul> <li>(c) They are not deemed to place the application in better appeal; and/or</li> </ul>	er form for appeal by materially re	ducing or simplifying	the issues for				
	(d) They present additional claims without canceling a c NOTE: (See 37 CFR 1.116 and 41.33(a)).	orresponding number of finally rej	ected claims.					
	4. The amendments are not in compliance with 37 CFR 1.12	1 See attached Notice of Non Co.	maliant Amerikan	(DTO) SO ()				
4. The amendments are not in compliance with 37 CFR 1.121. See attached Notice of Non-Compliant Amendment (PTOL-324 5. Applicant's reply has overcome the following rejection(s):								
	<ol> <li>Newly proposed or amended claim(s) would be allowed the non-allowable claim(s).</li> </ol>							
	<ol> <li>For purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is provious The status of the claim(s) is (or will be) as follows:</li> </ol>	] will not be entered, or b) 🛛 wil ded below or appended.	l be entered and an e	xplanation of				
	Claim(s) allowed: <u>4 and 8</u> .							
	Claim(s) objected to: Claim(s) rejected: 1-3,6 and 7.							
	Claim(s) rejected. 1-3,6 and 7. Claim(s) withdrawn from consideration:							
ė	AFFIDAVIT OR OTHER EVIDENCE							
	<ol> <li>The affidavit or other evidence filed after a final action, but because applicant failed to provide a showing of good and and was not earlier presented. See 37 CFR 1.116(e).</li> </ol>	before or on the date of filing a No sufficient reasons why the affidavi	tice of Appeal will <u>no</u> t or other evidence is	t be entered necessary				
•	<ol> <li>The affidavit or other evidence filed after the date of filing a entered because the affidavit or other evidence failed to over showing a good and sufficient reasons why it is necessary</li> </ol>	ercome all rejections under anneal	and/or annollant faile	. +				
	10. ☐ The affidavit or other evidence is entered. An explanation REQUEST FOR RECONSIDERATION/OTHER	of the status of the claims after en	try is below or attach	). ed.				
1	11. The request for reconsideration has been considered but	does NOT place the application in	condition for allowan	ce because:				
1	<ol> <li>Note the attached Information Disclosure Statement(s). (F</li> <li>Other: See Continuation Sheet</li> </ol>	TO/SB/08 of PTO-1449) Paper N	o(s)1 <u>41104</u> , 10/19/04	eand 1/19/0				

Continuation of 13. Other: Wensel discloses a resin package 224 cofigured to seal the semiconductor element 214, the lead frame 220 and the metal block 216 while uncovering the insulating layer 228, wherein the insulating layer 228 (copper alloys, aluminum alloys, etc., polyamides, and leadlock tape) [Wensel, column 5, lines 60-63] has a higher heat conduction than the resin package 224. Note, copper alloys, aluminum alloys, etc., polyamides, and leadlock tape has a higher heat conduction than the resin package 27.

HOAI PHAM